



## 8N80-C

Power MOSFET

### 8A, 800V N-CHANNEL POWER MOSFET

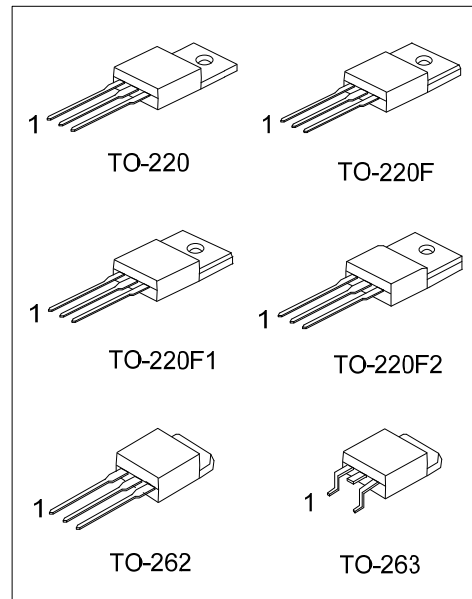
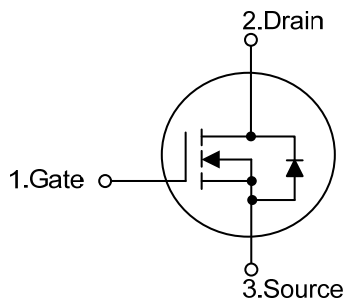
#### DESCRIPTION

The UTC **8N80-C** provide excellent  $R_{DS(ON)}$ , low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

#### FEATURES

- \*  $R_{DS(ON)} \leq 1.4\Omega @ V_{GS}=10V, I_D=4.0A$
- \* Fast Switching Capability
- \* Avalanche Energy Specified

#### SYMBOL



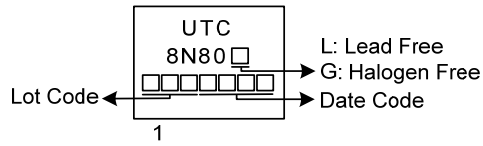
#### ORDERING INFORMATION

| Ordering Number |              | Package  | Pin Assignment |   |   | Packing   |
|-----------------|--------------|----------|----------------|---|---|-----------|
| Lead Free       | Halogen Free |          | 1              | 2 | 3 |           |
| 8N80L-TA3-T     | 8N80G-TA3-T  | TO-220   | G              | D | S | Tube      |
| 8N80L-TF1-T     | 8N80G-TF1-T  | TO-220F1 | G              | D | S | Tube      |
| 8N80L-TF2-T     | 8N80G-TF2-T  | TO-220F2 | G              | D | S | Tube      |
| 8N80L-TF3-T     | 8N80G-TF3-T  | TO-220F  | G              | D | S | Tube      |
| 8N80L-T2Q-T     | 8N80G-T2Q-T  | TO-262   | G              | D | S | Tube      |
| 8N80L-TQ2-T     | 8N80G-TQ2-T  | TO-263   | G              | D | S | Tube      |
| 8N80L-TQ2-R     | 8N80G-TQ2-R  | TO-263   | G              | D | S | Tape Reel |

Note: Pin Assignment: G: Gate D: Drain S: Source

|  |  |
|--|--|
| <p>8N80G-TA3-T</p> <p>(1)Packing Type</p> <p>(2)Package Type</p> <p>(3)Green Package</p> | <p>(1) T: Tube, R: Tape Reel</p> <p>(2) TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F, T2Q: TO-262, TQ2: TO-263</p> <p>(3) G: Halogen Free and Lead Free, L: Lead Free</p> |
|--|--|

■ MARKING



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■ ABSOLUTE MAXIMUM RATINGS ( $T_C = 25^\circ\text{C}$ , unless otherwise specified)

| PARAMETER                          |                              | SYMBOL    | RATINGS    | UNIT             |
|------------------------------------|------------------------------|-----------|------------|------------------|
| Drain-Source Voltage               |                              | $V_{DSS}$ | 800        | V                |
| Gate-Source Voltage                |                              | $V_{GSS}$ | $\pm 30$   | V                |
| Drain Current                      | Continuous                   | $I_D$     | 8.0        | A                |
|                                    | Pulsed (Note 2)              | $I_{DM}$  | 32         | A                |
| Avalanche Current (Note 2)         |                              | $I_{AR}$  | 8          | A                |
| Avalanche Energy                   | Single Pulsed (Note 3)       | $E_{AS}$  | 168        | mJ               |
| Peak Diode Recovery dv/dt (Note 4) |                              | dv/dt     | 1.5        | V/ns             |
| Power Dissipation                  | TO-220/TO-262<br>TO-263      | $P_D$     | 145        | W                |
|                                    | TO-220F/TO-220F1<br>TO-220F2 |           | 30         | W                |
|                                    |                              |           |            |                  |
| Junction Temperature               |                              | $T_J$     | +150       | $^\circ\text{C}$ |
| Storage Temperature                |                              | $T_{STG}$ | -55 ~ +150 | $^\circ\text{C}$ |

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3.  $L=10\text{mH}$ ,  $I_{AS}=5.8\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $R_G=25\ \Omega$ , Starting  $T_J = 25^\circ\text{C}$

4.  $I_{SD} \leq 8.0\text{A}$ ,  $di/dt \leq 200\text{A}/\mu\text{s}$ ,  $V_{DD} \leq BV_{DSS}$ , Starting  $T_J = 25^\circ\text{C}$

■ THERMAL RESISTANCES CHARACTERISTICS

| PARAMETER           |                              | SYMBOL        | RATINGS | UNIT                      |
|---------------------|------------------------------|---------------|---------|---------------------------|
| Junction to Ambient |                              | $\theta_{JA}$ | 62.5    | $^\circ\text{C}/\text{W}$ |
| Junction to Case    | TO-220/TO-262<br>TO-263      | $\theta_{JC}$ | 0.86    | $^\circ\text{C}/\text{W}$ |
|                     | TO-220F/TO-220F1<br>TO-220F2 |               | 4.2     | $^\circ\text{C}/\text{W}$ |
|                     |                              |               |         |                           |

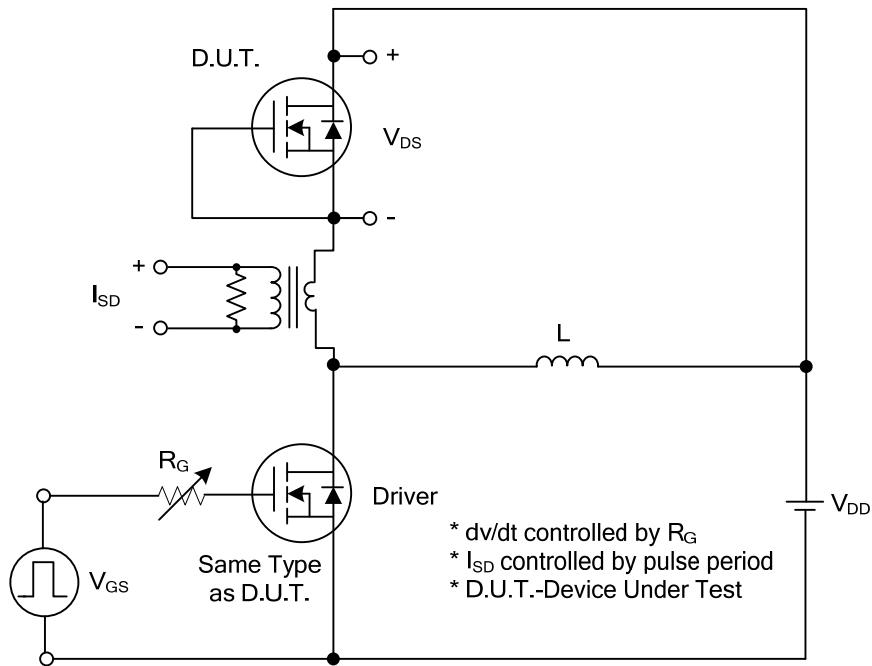
■ ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ , unless otherwise specified)

| PARAMETER  | SYMBOL       | TEST CONDITIONS   | MIN | TYP  | MAX       | UNIT     |
|--|--------------|---|-----|------|-----------|----------|
| <b>OFF CHARACTERISTICS</b>                             |              |   |     |      |           |          |
| Drain-Source Breakdown Voltage                         | $BV_{DSS}$   | $V_{GS}=0V, I_D=250\mu A$   | 800 |      |           | V        |
| Drain-Source Leakage Current                           | $I_{DSS}$    | $V_{DS}=800V, V_{GS}=0V$  |     |      | 10        | $\mu A$  |
| Gate-Source Leakage Current                            | $I_{GSS}$    | $V_{GS}=\pm 30V, V_{DS}=0V$                                       |     |      | $\pm 100$ | nA       |
| <b>ON CHARACTERISTICS</b>                              |              |   |     |      |           |          |
| Gate Threshold Voltage                                 | $V_{GS(TH)}$ | $V_{DS}=V_{GS}, I_D=250\mu A$                                     | 3.0 |      | 5.0       | V        |
| Static Drain-Source On-State Resistance                | $R_{DS(ON)}$ | $V_{GS}=10V, I_D=4.0A$  |     | 1.22 | 1.4       | $\Omega$ |
| <b>DYNAMIC CHARACTERISTICS</b>                         |              |   |     |      |           |          |
| Input Capacitance                                      | $C_{ISS}$    | $V_{GS}=0V, V_{DS}=25V, f=1MHz$                                   |     | 1320 |           | pF       |
| Output Capacitance                                     | $C_{OSS}$    |   |     | 149  |           | pF       |
| Reverse Transfer Capacitance                           | $C_{RSS}$    |   |     | 15   |           | pF       |
| <b>SWITCHING CHARACTERISTICS</b>                       |              |   |     |      |           |          |
| Total Gate Charge                                      | $Q_G$        | $V_{DS}=100V, V_{GS}=10V, I_D=10A$<br>$I_G=1mA$ (Note 1, 2)       |     | 35   |           | nC       |
| Gate-Source Charge                                     | $Q_{GS}$     |   |     | 9    |           | nC       |
| Gate-Drain Charge                                      | $Q_{DD}$     |   |     | 10   |           | nC       |
| Turn-On Delay Time                                     | $t_{D(ON)}$  | $V_{DD}=100V, V_{GS}=10V, I_D=10A,$<br>$R_G=25\Omega$ (Note 1, 2) |     | 25   |           | ns       |
| Turn-On Rise Time                                      | $t_R$        |   |     | 22   |           | ns       |
| Turn-Off Delay Time                                    | $t_{D(OFF)}$ |   |     | 105  |           | ns       |
| Turn-Off Fall Time                                     | $t_F$        |   |     | 48   |           | ns       |
| <b>SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS</b> |              |   |     |      |           |          |
| Maximum Continuous Drain-Source Diode Forward Current  | $I_S$        |   |     |      | 8         | A        |
| Maximum Pulsed Drain-Source Diode Forward Current      | $I_{SM}$     |   |     |      | 32        | A        |
| Drain-Source Diode Forward Voltage                     | $V_{SD}$     | $I_S=8.0A, V_{GS}=0V$   |     |      | 1.4       | V        |
| Body Diode Reverse Recovery Time                       | $t_{rr}$     | $I_S=8.0A, V_{GS}=0V, dI_F/dt=100A/\mu s$                         |     | 520  |           | ns       |
| Body Diode Reverse Recovery Charge                     | $Q_{rr}$     |   |     | 6    |           | $\mu C$  |

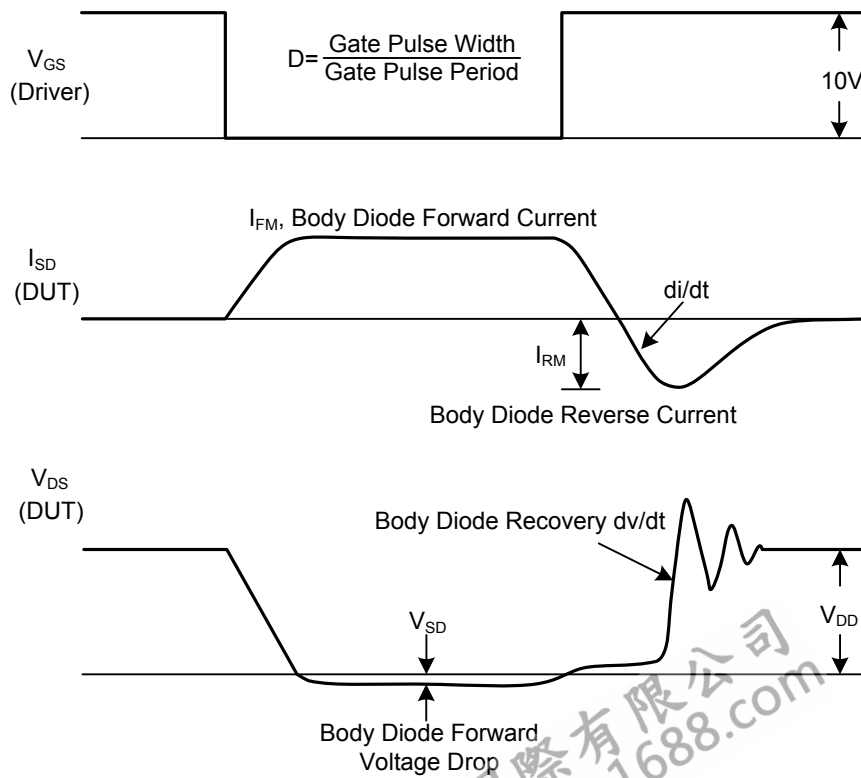
Notes: 1. Pulse Test: Pulse width  $\leq 300\mu s$ , Duty cycle  $\leq 2\%$ .

2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

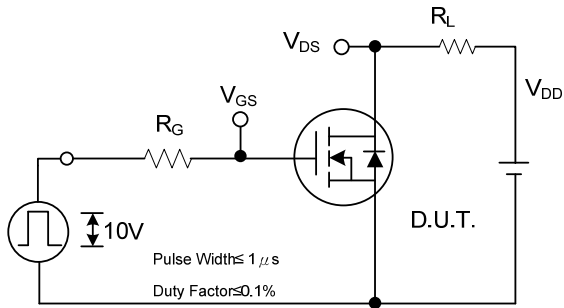


Peak Diode Recovery  $dv/dt$  Test Circuit

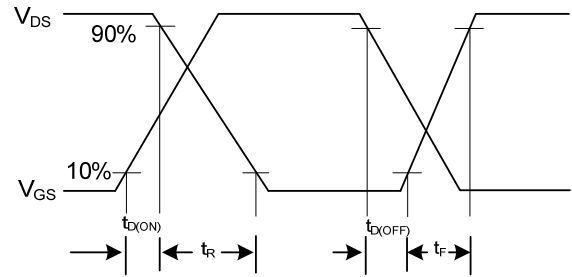


Peak Diode Recovery  $dv/dt$  Waveforms

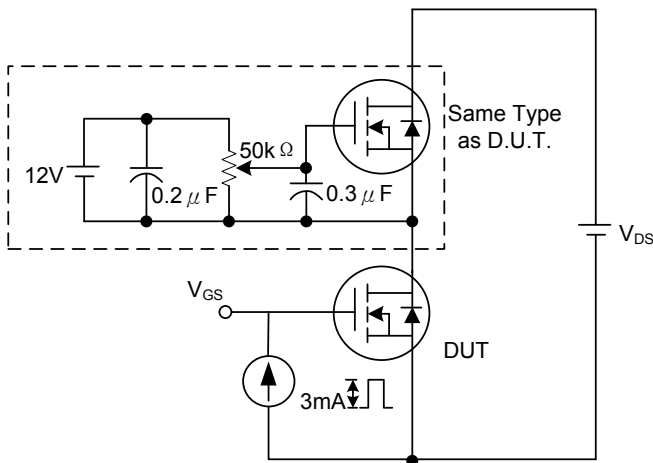
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



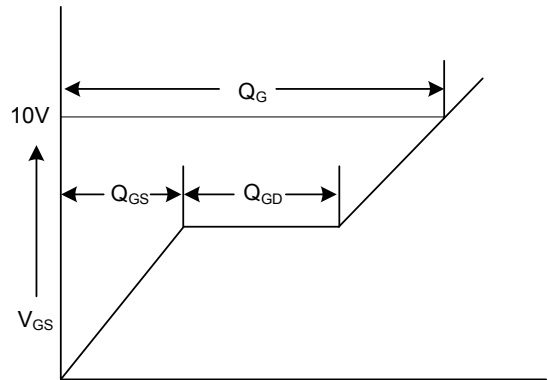
Switching Test Circuit



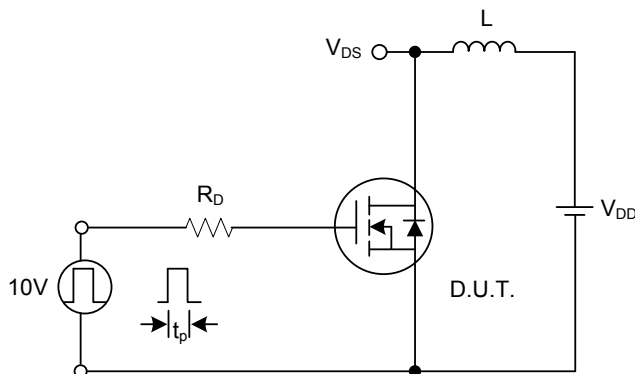
Switching Waveforms



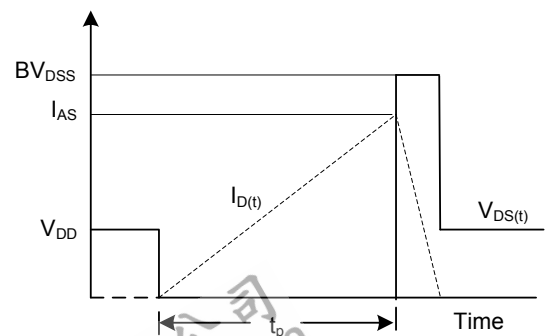
Gate Charge Test Circuit



Charge Gate Charge Waveform

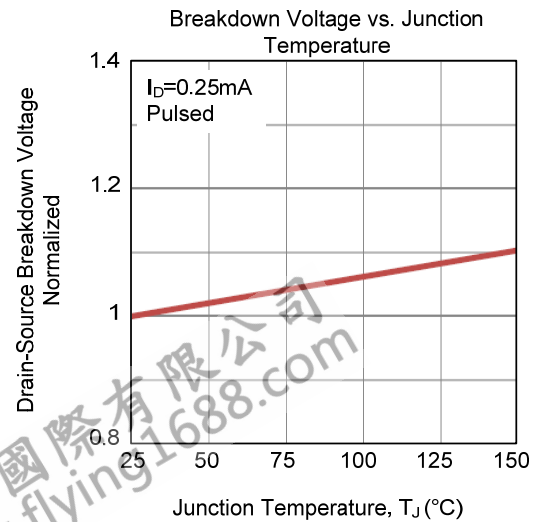
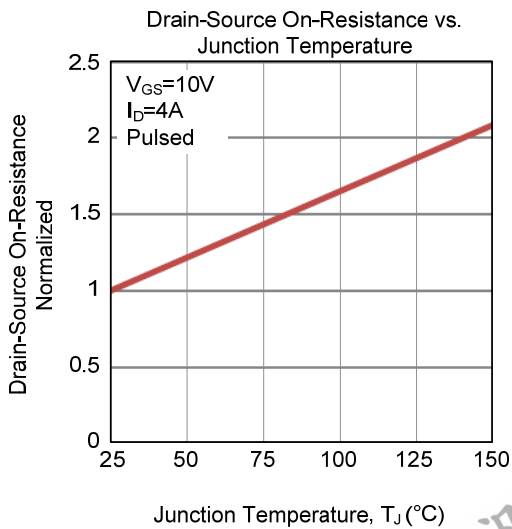
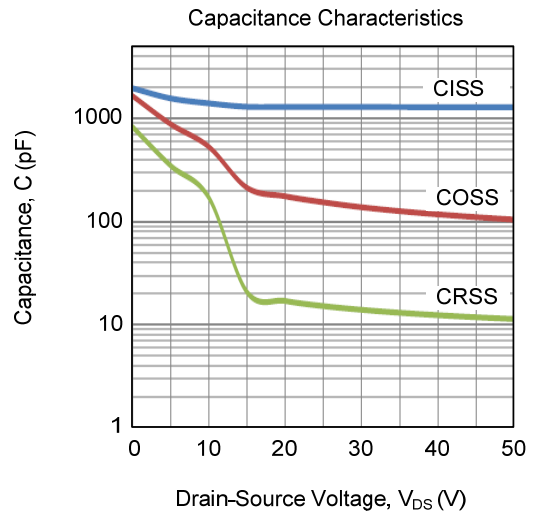
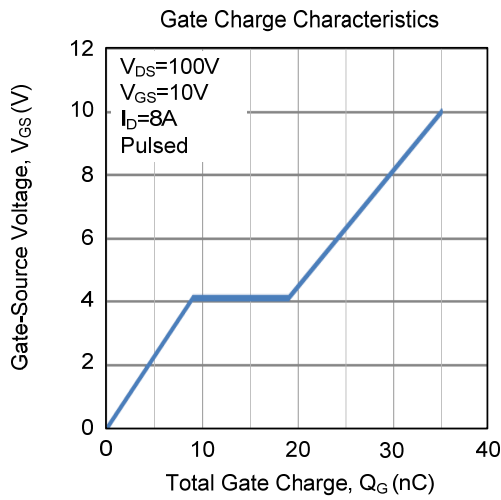
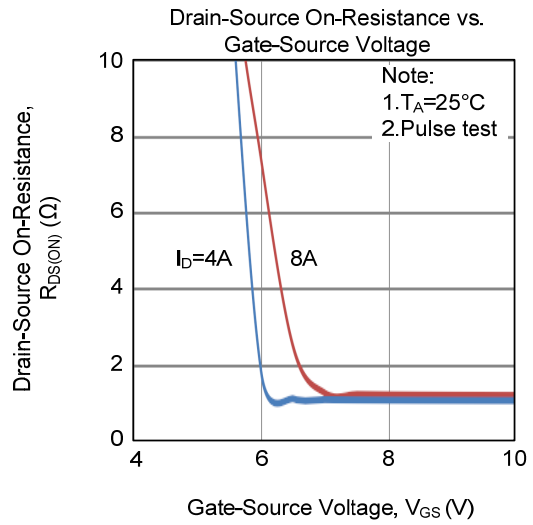
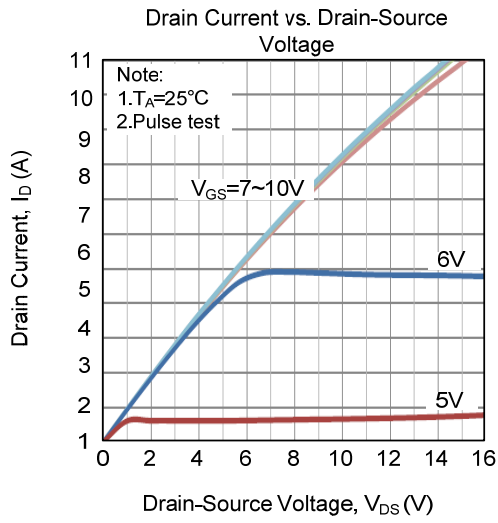


Unclamped Inductive Switching Test Circuit

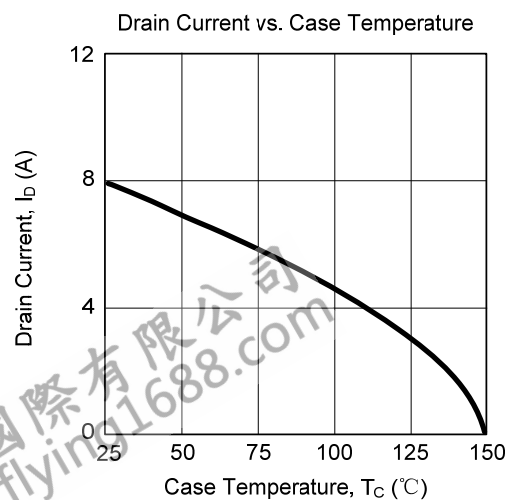
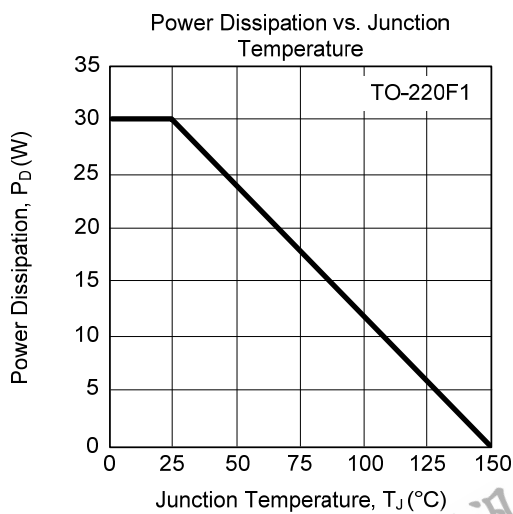
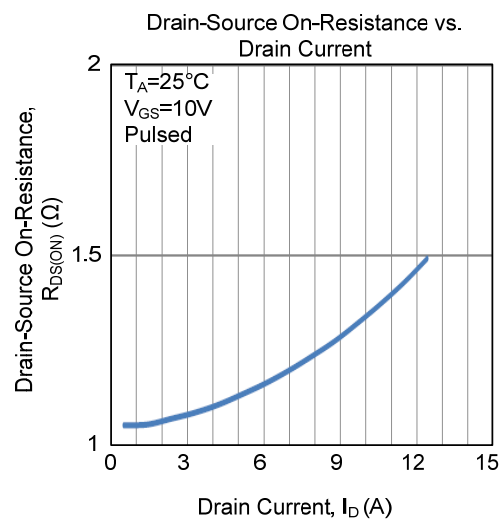
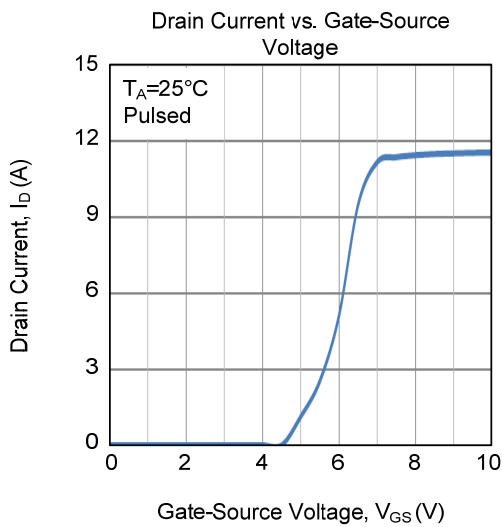
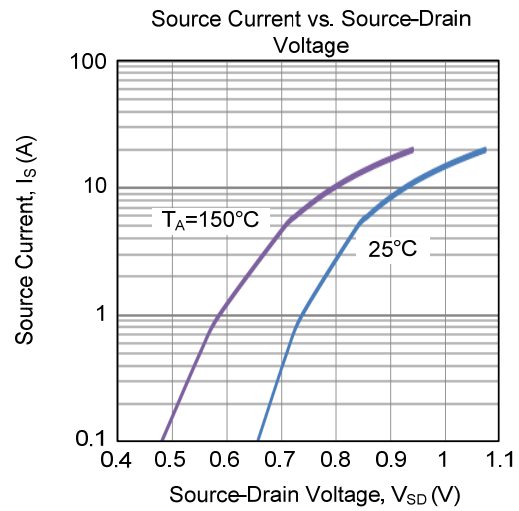
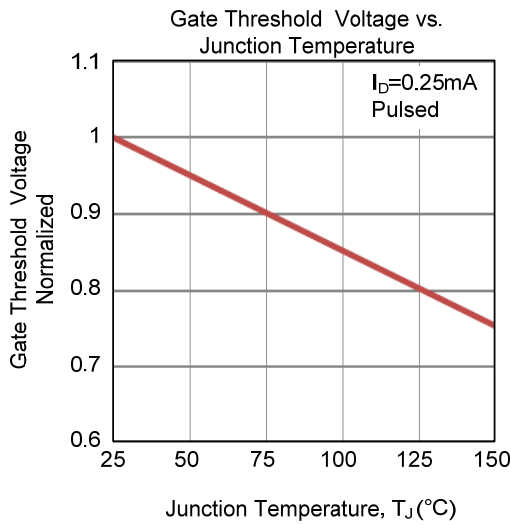


Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS

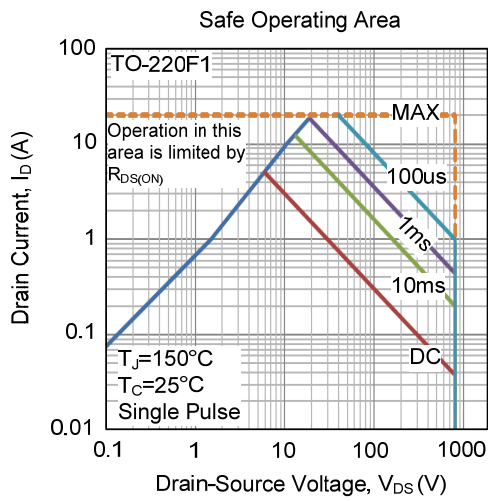


■ TYPICAL CHARACTERISTICS (Cont.)





■ TYPICAL CHARACTERISTICS (Cont.)



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